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Attorney Docket No. 1374.46206X00

To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

Teruo SHOJI
Akio HASEBE, Yoshinori DEGUCHI, Motoji MURAKAMI, Masayoshi
OKAMOTO, Yasunori NARIZUKA, Susumu KASUKABE

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

2. Name and address of receiving party(ies)

Name: **RENASAS TECHNOLOGY CORP.**

Street Address: 4-1, Marunouchi 2-chome, Chiyoda-ku
Tokyo, Japan

City: State: Zip:

Additional name(s) & address(es) attached? ☐ Yes ☒ No

3. Nature of conveyance/ Execution Date: March 29, 2006, March 29,
2006, March 30, 2006, March 30, 2006, April 13, 2006, March 30, 2006,
April 10, 2006

- ☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Joint Research Agreement
☐ Government Interest Assignment
☐ Executive Order 9424, Confirmatory License
☐ Other .

4. Application number(s) or patent number(s):
application **June 7, 2006.**

A. Patent Application No.(s)

☐ This document is being filed together with a new

B. Patent Registration No.(s)

Additional number(s) attached ☐ Yes ☒ No

5. Name and address of party to whom correspondence
concerning document should be mailed:

Name: **ANTONELLI, TERRY, STOUT & KRAUS, LLP**

Internal Address:

1300 NORTH 17TH STREET - SUITE 1800City: **ARLINGTON** State: **VA** Zip **22209**

Phone Number: (703) 312-6600
Facsimile Number: (703) 312-6666
Email Address: email@antonelli.com

6. Total number of applications and patents involved **1**7. Total fee (37 CFR 3.41)..... **\$40.00**

- ☒ Authorized to be charged by credit card
☐ Authorized to be charged to deposit account
☒ Enclosed
☐ None required (government interest not affecting title)

8. Payment Information:

- a. Credit Card Last 4 numbers: 1107
Expiration date: 06/10
b. Deposit account number: 01-2135

Authorized User Name: Paul J. Skwierawski

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9. Statement and signature.

*To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy
is a true copy of the original document.*

William I. Solomon, Reg#28,565

Name of Person Signing

Signature

06/07/2006

Date

Total number of pages including cover sheet, attachments, and document: **2**

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PATENT
REEL: 017981 FRAME: 0289

ASSIGNMENT

(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Renesas Technology Corp., a corporation organized under the laws of Japan, located at 4-1, Marunouchi 2-chome, Chiyoda-ku, Tokyo, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said Renesas Technology Corp., its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

MANUFACTURING METHOD OF SEMICONDUCTOR INTEGRATED CIRCUIT DEVICE

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said Renesas Technology Corp., its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Renesas Technology Corp.,

Signed on the date(s) indicated aside our signatures:

INVENTOR(S)
(発明者フルネームサイン)

Date Signed
(署名日)

1) <u>Teruo Shoji</u> Teruo SHOJI	<u>29 / March / 2006</u>
2) <u>Akio Hasebe</u> Akio HASEBE	<u>29 / March / 2006</u>
3) <u>Yoshinori Deguchi</u> Yoshinori DEGUCHI	<u>30 / March / 2006</u>
4) <u>Motoji Murakami</u> Motoji MURAKAMI	<u>30 / March / 2006</u>
5) <u>Masayoshi Okamoto</u> Masayoshi OKAMOTO	<u>13 / Ap / 2006</u>
6) <u>Yasunori Narizuka</u> Yasunori NARIZUKA	<u>30 / March / 2006</u>
7) <u>Susumu Kasukabe</u> Susumu KASUKABE	<u>10 / april / 2006</u>
8) _____	_____
9) _____	_____
10) _____	_____

PATENT

RECORDED: 06/07/2006

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